

**Terms and Conditions governing submissions to the  
Texas Instruments Innovation Challenge: India Analog Design Contest 2014**

Please read and accept the following terms and conditions prior to making any submissions or providing any ideas or materials to Texas Instruments (India) Private Limited ("TI") in respect of the Texas Instruments Innovation Challenge: India Analog Design Contest 2014. All submissions made for the contest are subject to these terms and conditions and by making the submission, you would be deemed to have unconditionally acknowledged and accepted the same:

1. The evaluation, use and publication of materials, designs and/or ideas submitted by participants in the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 is the sole prerogative of the TI management. The manner, mode, form and timing of evaluation, use or publication, as also the alteration, deletion, addition and editing of content of the materials, designs or ideas submitted to TI as part of the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 shall be determined by TI's management at its sole discretion. No causes shall be required to be furnished by TI to any participant in respect of the acceptance, rejection, and alteration or editing of any materials, designs or ideas submitted by such participant. TI reserves the right to withhold the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 results from you and/or all or any of the participants without specifying any reasons in that regard.
2. By making a submission as part of the Texas Instruments Innovation Challenge: India Analog Design Contest 2014, you expressly agree to irrevocably, perpetually and exclusively grant and assign in favour of Texas Instruments (India) Private Limited (TI), without any geographical restriction and on a royalty free basis, all rights, title and interest, including but not limited to patents, designs, mask-works, copyright and rights of reproduction, re-use and moral rights, in respect of the materials, designs and/or ideas submitted by you to TI. Upon submission to TI, you shall cease to enjoy or retain any right, title or interest over the material, design or idea in question. You agree to duly sign and execute all documents as may be needed by TI to give effect to the above grant/assignment. The fact that such materials, designs and/or ideas could potentially make you eligible for awards offered by TI to a winning participant of the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 forms sufficient consideration for the above grant and assignment, irrespective of whether or not you are finally selected as the winner of the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 or provided any award or recognition by TI.
3. All materials, designs and ideas submitted by you to TI must be bona-fide original works attributable to yourself and must not in any manner infringe any third party intellectual property rights or incorporate the intellectual property of a third party (except as expressly authorized by such third party and notified by you to TI in writing along with the submission). Finally, no proprietary, confidential or sensitive materials belonging to a third party should be submitted to TI and TI is not in a position to assure confidentiality in respect of the submission. In the event of any non-

compliance with the foregoing, you hereby agree to indemnify and keep indemnified TI and its group companies and their directors, officers and employees against all losses, claims, damages, liabilities and expenses (including attorney fees) incurred by TI and its group companies and their directors, officers and employees consequent to such non-compliance.

4. You shall ensure that you comply with all applicable laws and the policies and procedures of your employer/educational institution in making the submissions for the Texas Instruments Innovation Challenge: India Analog Design Contest 2014. TI has no duty to check your submissions for such compliance and you alone shall be responsible for all consequences of failing to adhere to the pertinent laws, policies or procedures.
5. Nothing in the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 or in any subsequent interview or interaction with TI personnel shall be construed as creating any obligations upon TI vis-à-vis you or any third parties. Without prejudice to the foregoing, allowing you to participate in the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 and any subsequent interview or interaction shall not be deemed an offer of employment with TI.
6. TI makes no warranties whatsoever, whether express or implied, in respect of the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 and any subsequent interview or interaction and hereby disclaims all liability to you and all other participants in respect of acts or omissions regarding the conduct of the same and any decisions made by TI with respect to selection of winning entries or use of submitted materials, designs or ideas. TI shall not accept any liability in respect of any errors or oversights in conducting the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 and selecting winning participants.
7. You shall not indulge in any unfair or unethical means in order to improve your chances of winning the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 and if you are found doing so, you shall be liable, without prejudice to any other rights or remedies enjoyed by TI, to be summarily removed from participating further in the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 without any explanations being entertained. You must refrain from sharing the details of your Texas Instruments Innovation Challenge: India Analog Design Contest 2014 submissions or TI's responses in that behalf with any other participants or persons except as specifically permitted by TI.
8. You shall abide by all Texas Instruments Innovation Challenge: India Analog Design Contest 2014 related rules and guidelines as may be communicated to you by TI's representatives and shall not question the same. TI expressly reserves the right to modify the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 related rules, guidelines and awards as well as these terms and conditions at any time without being required to notify or seek consent from you or any other participants.

9. TI is not liable to reimburse any expenses that may have been incurred by you with a view to participating in the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 and shall not accept any claims in that regard.
10. All awards and payments made by TI in respect of the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 shall be subjected to tax and other statutory deductions at source as mandated by law. Any and all taxes, surcharges, cesses and charges in respect of the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 awards shall be borne by the winners alone and TI shall not be liable for the same.
11. TI's decision in respect of any matter concerning the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 and any subsequent interview or interaction shall be final and binding upon you and you shall accept the same without demur. In any event, all disputes amongst TI and you or any third parties claiming through you shall be subject to the sole jurisdiction of the courts at Bangalore, India.

In the event that any of the above terms are unacceptable to you, please refrain from participating in the Texas Instruments Innovation Challenge: India Analog Design Contest 2014.

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products	Applications
Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>
DLP® Products	<a href="http://www.dlp.com">www.dlp.com</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>
Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>
RFID	<a href="http://www.ti-rfid.com">www.ti-rfid.com</a>
OMAP Applications Processors	<a href="http://www.ti.com/omap">www.ti.com/omap</a>
Wireless Connectivity	<a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a>
	<b>TI E2E Community</b>
	<a href="http://e2e.ti.com">e2e.ti.com</a>